

EONTM
pc-based controller
user guide
for vers. 3.0.8 software

Contents

7	Chapter 1: Eon™ at a Glance
7	Eon™ Connectors
9	Accessories
12	Mirage™ Air-Cooling System
14	Chapter 2: Getting Started
14	Eon™ System Assembly
20	Chapter 3: Program Control
20	Program Control Screen
20	Process List
21	Layer List
21	Layer Properties List
24	Layer Properties Defined
26	Chapter 4: Heater Control
26	Heater Control Screen
27	Heating Cycle List
27	Heater Settings List
29	Heater Control Buttons
30	Heater Thermostat
30	Temperature & Power Indicators
31	Advanced Settings
32	Chapter 5: Settings
32	Settings Screen
32	Backup & Restore
33	Sensor Alerts
34	Log
34	Restore Defaults
34	Period Control
35	Relay Control
36	Heater Constant Controls
37	Sensor Zeroing

Contents

38	Chapter 6: Manual Mode
38	Manual Control
38	Adjusting Source & Heater Power
39	Exiting Manual Mode
40	Chapter 7: Vertical Tool Bar
40	Using the Vertical Tool Bar
40	Starting a Deposition
41	Aborting a Process
41	Resume or Restart an Aborted Process
41	Logging Eon™ Status
41	Zeroing the Sensors
41	Activating Relay 1 and Relay 2
41	Switching to Manual Mode
42	Exiting Eon™ Software
43	Chapter 8: Status
43	Status Screen
44	Health, Layer, Material, Frequency, Rate, and Thickness
44	Zero Sensor
44	Percentage Complete
44	Source Power
45	Temperatures
45	Manually Zeroing Individual Sensors
46	Chapter 9: Green Status Bar
46	Status Indicators and Remote Process Control
47	Chapter 10: Graphs
47	Graph Screen
47	Adjusting Y Values
48	Graphs
48	Color Key

Contents

49	Chapter 11: Screen Lock
49	Password-Protect Eon™ Screens
49	Screen Lock Button
50	Locking a Screen
50	Setting a New Password
51	Resetting the Password
52	Chapter 12: Troubleshooting
53	Chapter 13: Specifications
53	Device Parameters
53	Coating
54	Measurement
54	Process Display
54	Communications
55	Inputs and Outputs

Appendices

56	Appendix A: Tempe-Eon™ System
56	Tempe-Eon™ System Configuraton
57	Appendix B: Quick Info
57	Screen Selection Tool Bar
57	Adding a Process
57	Renaming a Process
57	Deleting a Process
58	Edit the Name, Rate, and Thickness of a Process
58	Adding a Layer to a Process
58	Re-ordering the Layers
58	Changing Properties of a Layer
59	Layer Properties List
60	Removing a Layer
60	Deleting a Layer
60	Changing the Material for a Layer
61	Selecting Sensor
61	Heater Control
61	Creating a Heater Cycle
62	Cleaning the Sensor with a Heater
62	Clean Settings
63	Vertical Tool Bar
65	Settings
67	Appendix C
68	About Eon™
68	LabVIEW Interface
68	Software Updates
68	Inspection & Initial Setup
68	Warranty
70	Appendix D
70	Tooling Factor

Miscellaneous

70 [Index](#)

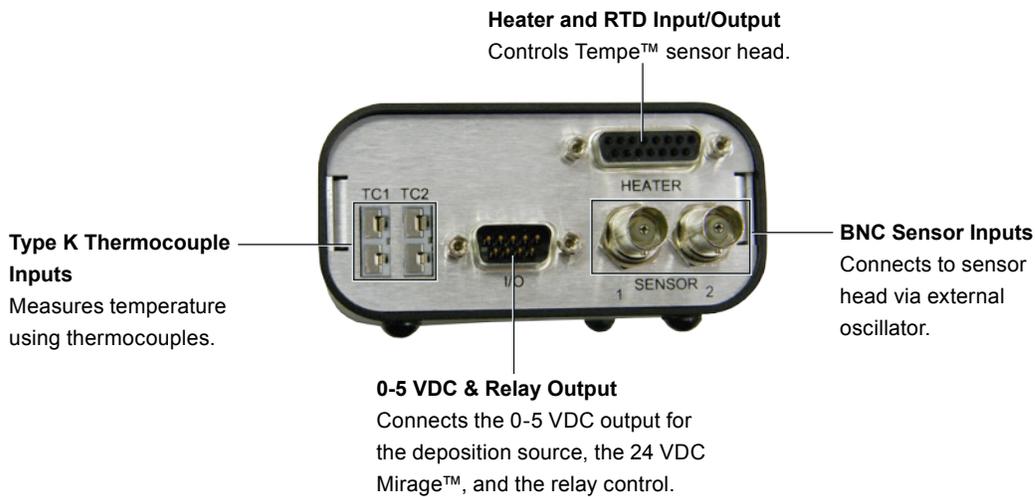
Eon™ at a Glance

1

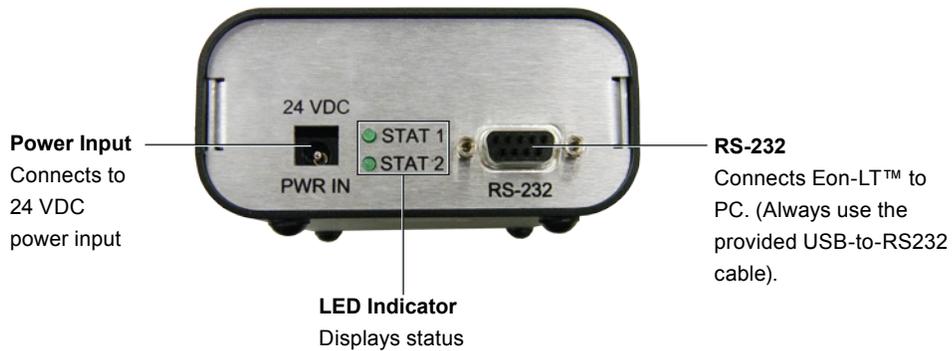
This guide describes Eon™ controller with temperature control (3rd generation) and Eon™ software ver 3.0.

Eon™ Connectors

Eon™ Front



Eon™ Back





WARNING Make sure the correct hardware is used with Eon™ inputs and outputs. See proper setup procedures in this manual and in the Tempe-Eon™ quick reference guide.

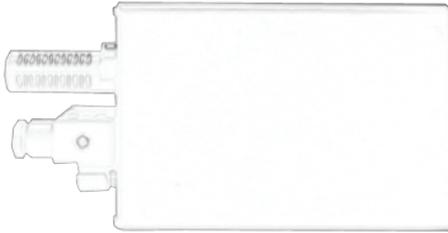


WARNING Only the provided power supply should be used with Eon™. Not doing so will damage product and void warranty. Make sure power supply has a 24 VDC.

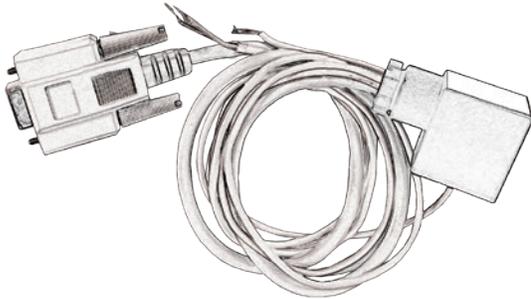
Accessories

The Eon™ ships with a variety of accessories.

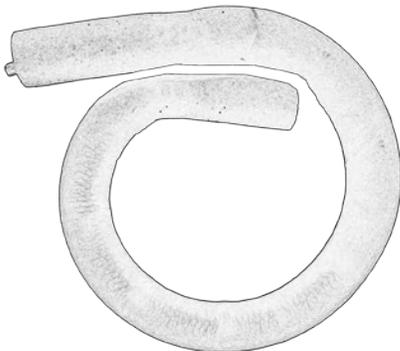
Mirage™ air-cooling system. As part of the Eon™ temperature-compensation system, this cooling accessory channels compressed, cold air into the Tempe™ sensor in order to maintain consistent temperatures inside crystal compartment.



Mirage power adapter. Combines Mirage™ power supply and relay cables.



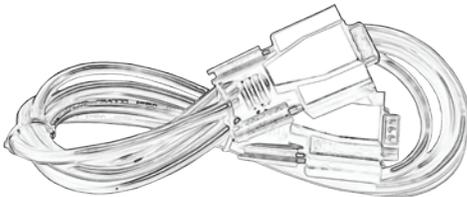
Mirage air-cooling tube. Delivers cold air into sensor head cooling tubes.



Power supply and cable. Input 100-200 VAC, 50/60Hz, 2 A. Output 24V, 3.75 A, 90W Max.



RS-232 extension cable. Male-to-female serial cable.



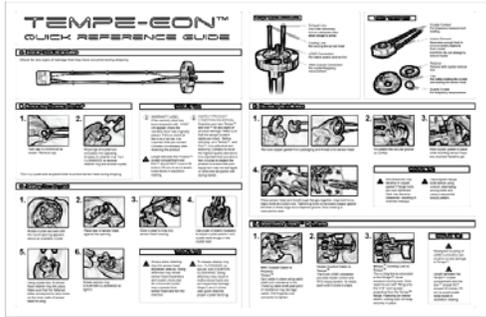
USB to RS-232 adaptor. Connects RS-232 cable and PC.



External oscillator. Replaces the Eon™ internal oscillator.



Tempe-Eon™ quick reference guide. Instructs user in quickly assembling and integrating Eon™ into existing system.

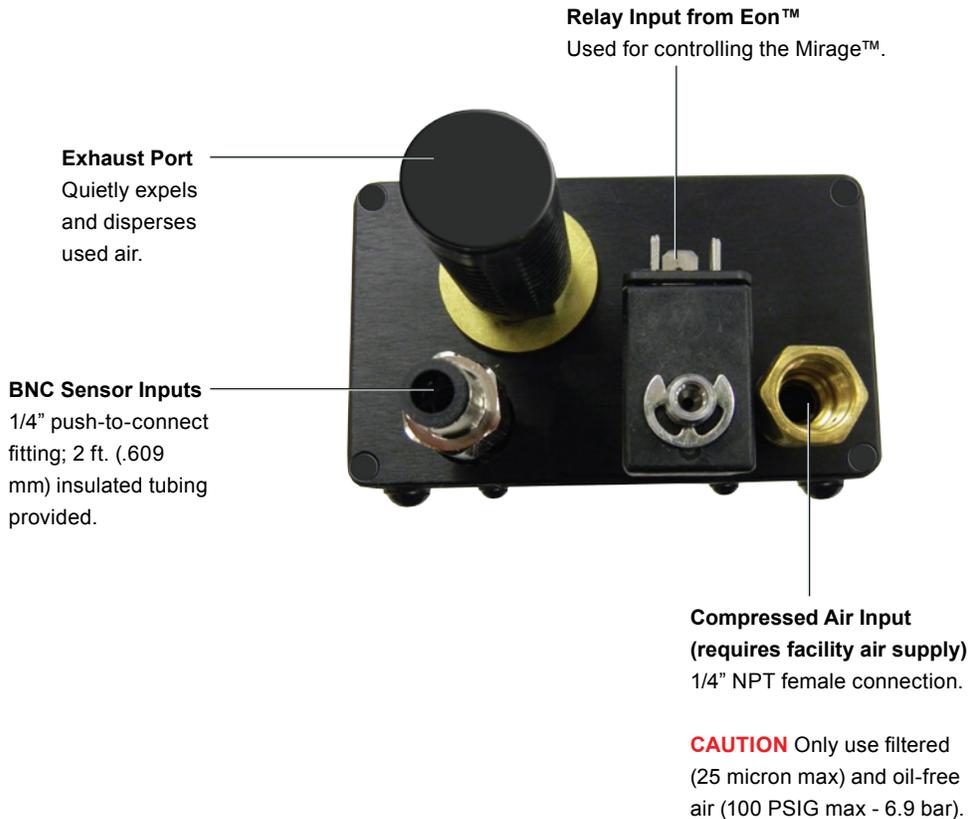


Software CD. Contains Eon™ software suite.



Mirage™ Air-Cooling System

The self-heating Tempe™ sensor employs a unique cooling system called the Mirage™ Air-Cooling System that connects through the DB-9 port. The Mirage™ forces cold air through the Tempe™ crystal compartment to counterbalance heat.



How it works

In order to achieve and maintain a specific target temperature on the crystal, the Tempe™ first heats the crystal to the temperature set in the deposition control menu of the Eon™ GUI. If the Tempe™ exceeds the desired temperature, the Mirage™ is triggered, blasting the crystal compartment with cold air and returning the crystal surface to the desired temperature. This type of regulated, hot-to-cold ratio control mechanism is capable of sustaining a tolerance of +/-1° C.

Because it is triggered by a simple relay input, the Mirage™ can be used as a cooling device in other applications.

Mirage™ Features

Refrigerant-Free Air Cooling

Not only maintenance free and environmentally safe, but when using regulated air the Mirage™ is easily capable of holding the sensor to a tolerance of +/-1°C.

Maintains Temperature up to 500°C

The Mirage™ produces a temperature output capability of 28°C (50°F) BELOW the supply air temperature, allowing the Tempe™ sensor head to maintain any temperature within 50-500°C.

Quiet Operation

While the cold air output is connected to the Tempe™ sensor head through a cooling line, the Mirage™ reduces noise by muffling and dispersing the hot air output.

Versatility of Application

Working from a simple relay input, the Mirage™ can be used as a cooling device in alternative applications.



WARNING Operating temperature SHOULD NOT be allowed to exceed 500°C. Equipment damage will likely result.

Getting Started

2

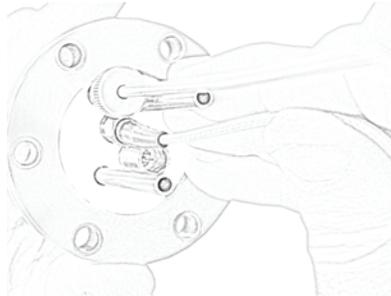
Eon™ System Assembly

The following guide will describe in detail how to integrate the Eon™ controller into a basic QCM configuration. The QCM depicted below is the Colnatec Tempe™ sensor head featuring temperature control technology. If using an alternative QCM, skip the steps highlighted in red. (See Appendix A for connection map of a fully assembled Tempe-Eon™ system).

Connecting to QCM

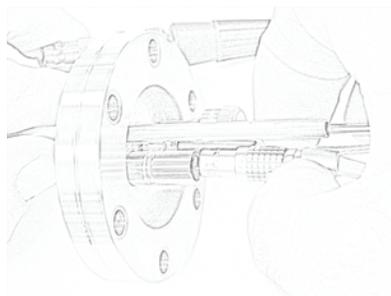
1. BNC Coaxial Cable to QCM

Spin cable in place using cable shaft until resistance is felt. (Twisting cable shaft past point of resistance may damage cable). Roll fingertip over connector to tighten.



2. Heater Control Cable to QCM

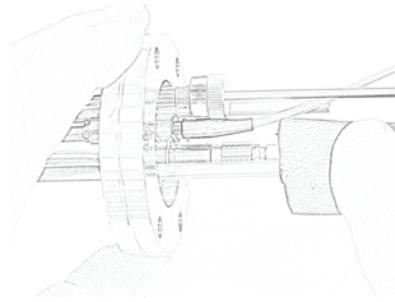
The 4-pin LEMO™ connector provides heater control and TC measurement. To install, push until it clicks in place. The other end is a DB-15 that connects to the DB-15 heater port on the Eon™ deposition controller.



WARNING Misaligned coupling of LEMO connectors can result in severe damage to Tempe™.

3. **Mirage™ cooling line to QCM**

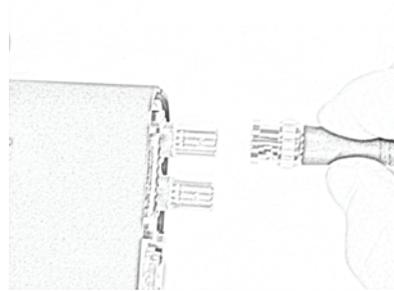
The cooling line is connected to the Mirage™ via an insulated cooling tube. Slide “push-to-connect” fitting onto the 3/16” cooling pipe projecting from the QCM flange. Featuring an interior detent, cooling tube will snap securely in place.



Connecting to Eon™

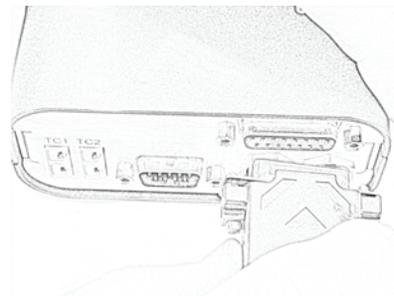
1. **BNC Coaxial Cable to Eon™**

Slide coaxial connector onto BNC.



2. **Heater Control Cable (DB-15 Connector) to Eon™**

Plug DB-15 connector into the Eon™ 15-pin male heater port.

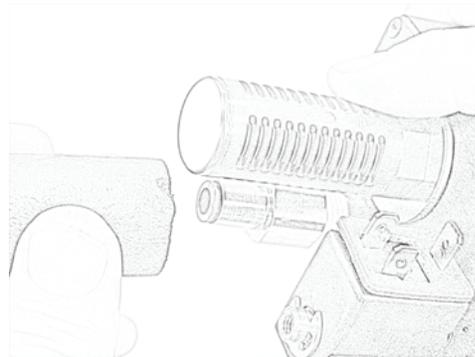


WARNING DO NOT allow operating temperature to exceed 500°C. Equipment damage will likely result.

Hardware and electronics

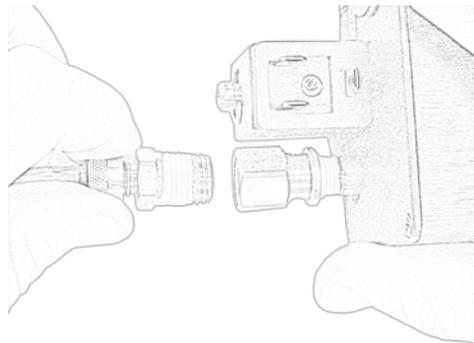
1. Cold Air Output from Mirage™ to Tempe™

Slide the 3/16" tube onto the "push-to-connect" fitting on rear of the Mirage™ cooling system. The Mirage™ provides a maximum output of 28°C (50°F) below the compressed air source.



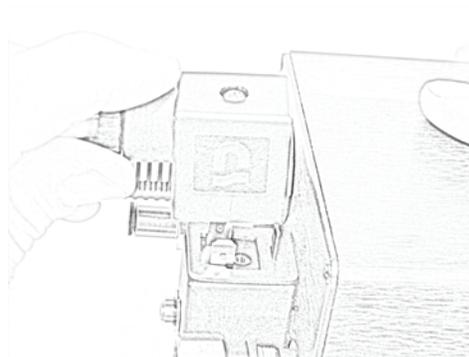
2. Compressed Air Input to Mirage™

Connect the Mirage™ to a filtered and oil-free compressed air source. (Air fittings may vary by country but require a 1/4 NPT female connection.)



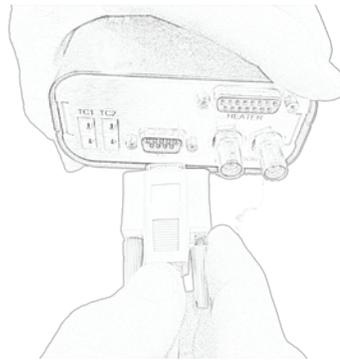
3. Eon™ Supplies Power to Mirage™ through Power Module

The 3-pin solenoid module provides power to Mirage™. Tighten integrated screw after mating to Mirage™. The DB-9 connector on other end attaches to male I/O port on Eon™.



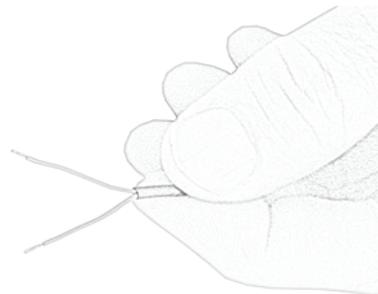
4. Connect Mirage™ Cable to Eon™

Connect 9-pin female-side of Mirage™ cable to Eon™ I/O port.



5. Relay Cable from Eon™ to Mirage™

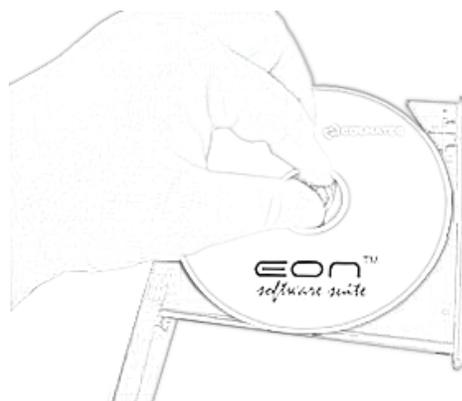
Part of the DB-9 connector cable bundle that plugs into the Eon™ I/O port and relay provides a 2-wire interface for switching.



Connecting Eon™ to PC

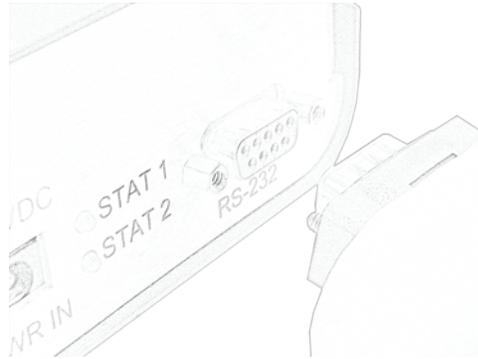
1. Install Eon™ Software onto PC

Insert the accompanying Eon™ software CD into disc drive. Follow prompts to install software onto PC.



2. **RS-232 to Eon™**

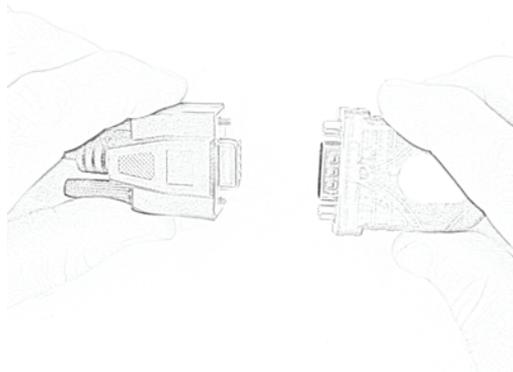
Plug RS-232 connector into female serial port on rear panel. Tighten integrated screws.



3. **RS-232 cable to USB**

Adapter

Plug the other end of the RS-232 cable into the USB-to-RS-232 adapter. Tighten integrated screws.



4. **Plug USB-to-RS-232**

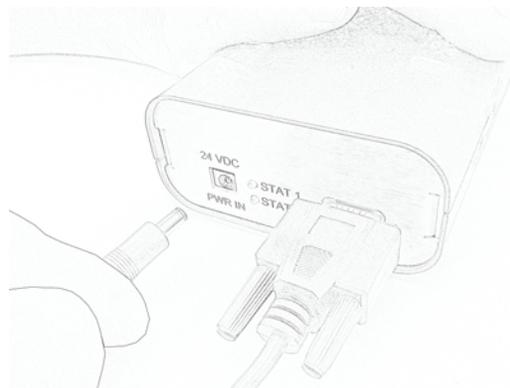
Adapter into PC

Plug USB-end of the USB-to-RS-232 adapter into PC.



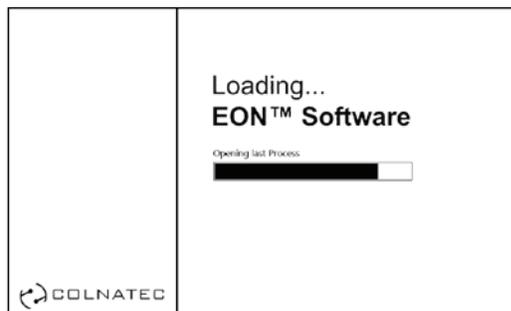
5. **Connect Power to Eon™**

Plug Eon™ power adapter into AC outlet. Then plug DC connector into the Eon™.



6. **Start Eon™ Software**

Start Eon™ software and follow the First Start setup procedure described in the Eon™ User Manual (available on the Eon™ software CD).



If drivers are already installed, simply update the drivers when installing software.

Use only the provided USB cable.

Ensure that the software has been fully installed before connecting **Eon™ to your PC**.

Reboot PC following Eon™ software installation.

Program Control

3

Program Control Screen

Click the Program button in the Control Menu to access the Program screen. With this screen you will be able to create a new process, edit or delete an existing process, as well as add or remove layers and layer properties.



Process List

Create a new process, or edit or delete an existing process. The list contains all of the available processes.

Create a new process. Selecting the New button located below the Process List allows you to create and name a new process. Choose either Sequential or Co-Deposition, enter name, and press OK. The process now appears on the Process List.

Delete a process. Pressing delete will permanently delete a process. Once deleted, a process is only recoverable if it was backed up prior.

Renaming a process. Double-click a process in the Process Layers List.



Layers List

Open the Layers List. Click a process name. Layers List displays the current layers associated with a process. Set the rate, thickness, name, and order of the layers.

Add a layer. Click a process name

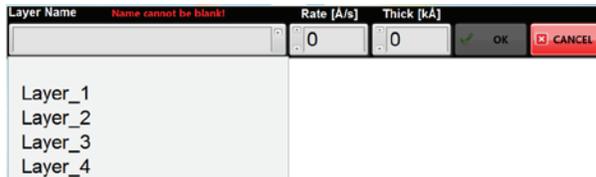
Select a layer. Single-click.

Edit layer name, rate, and thickness. Double-click a layer. Modify the name, rate, and/or thickness. Click OK.



Change order of layers. On the Layers List click and hold a layer, drag the layer up or down the list, and release the layer where desired.

Create new layer. Select New button located below the Layers List. You can also use an existing layer by typing in the layer name or pressing the dropdown arrow to reveal a list of currently available layers.



Layer Properties List

Enter or change values for layers. The Layer Property Value window allows you to enter or change the value of a layer property. (Note: Material, Source, and Sensor operate differently than the other items listed on the Layer Properties List).

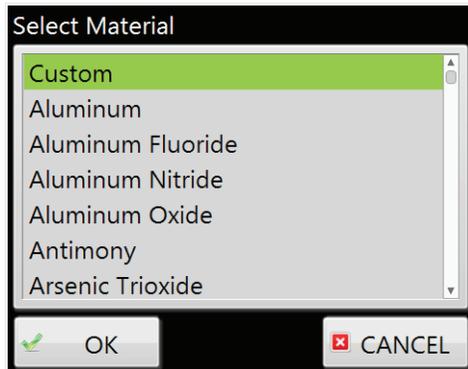
Open Layer Property Value window. Double-click a layer property at any time, even during a process run.



Enter a value and click OK or Cancel.

Permanently remove layer. Use the Permanently Remove Layer button to delete a selected layer. A deleted layer is removed from ALL processes (including those not selected). Once deleted, a layer is only recoverable if it was backed up prior.

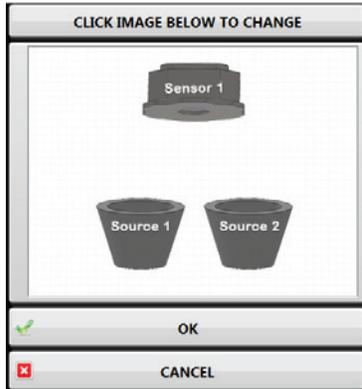
Select a material. Scroll down and click on the Material row to open the Materials List. Select the applicable material and double-click a material or click OK. The correct density and Z-Factor is automatically set.



Materials list.

If the material being applied in your process is unlisted, select Custom and click OK. You can then manually enter your custom Density and Z-Factor settings in the Layer Properties List. Note also that whenever you manually change Density and Z-Factor settings to an unlisted material, the software will automatically classify the material as "Custom".

Selecting Sources and Sensors. In the Layer Properties List, click on either Source or Sensor to open the Source/Sensor configuration window.



Source and sensor selector.

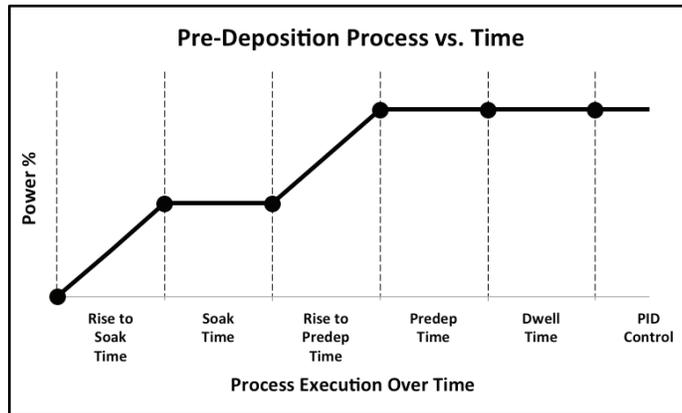
Click the image to configure which sensors and sources will be used during deposition. Select one of four configurations:

- **Source 1 → Sensor 1**
- **Source 2 → Sensor 1**
- **Source 1 → Sensor 2**
- **Source 2 → Sensor 2**

Layer Properties Defined

The following is a list of settings that defines the parameters of the deposition. All settings must be set correctly for the software to function properly.

- **Materials**
The material being applied during the deposition process. This entry turns to “Custom” if the Density or Z-Factor is modified by the user, in order to prevent mismatch.
- **Density**
The density of the selected material being applied.
- **Z-Factor**
Acoustic impedance factor which is used to compensate for dense materials and is pre-defined based on the selected material.
- **Tooling [%]**
The geometric relationship between the substrate and the positioning of the sensor.
- **Max Power [%]**
Represents the maximum power level Eon™ will deliver to the source [from 0%-100%], even when the heater requires more power to reach the setpoint temperature.
- **Proportional**
The proportional coefficient that controls the material deposition rate during the PID phase.
- **Integral**
The integral time constant that controls the material deposition rate during PID phase.
- **Derivative**
The derivative time constant that controls the material deposition rate during the PID phase.
- **Dwell Time**
The time specified that follows the completion the pre-deposition process before activation of the PID. This delay prevents the PID from engaging the source power prematurely, giving the material a chance to reach the sensor. (No material is applied to the sensor directly after the predeposition process finishes, for the brief time it takes for the material to initially transition from the source to the crystal in the event that a shutter is present).
- **Rise to Soak Time**
The time specifying how long it takes Eon™ to raise source power from 0% to desired soak power



Pre-deposition process vs. time

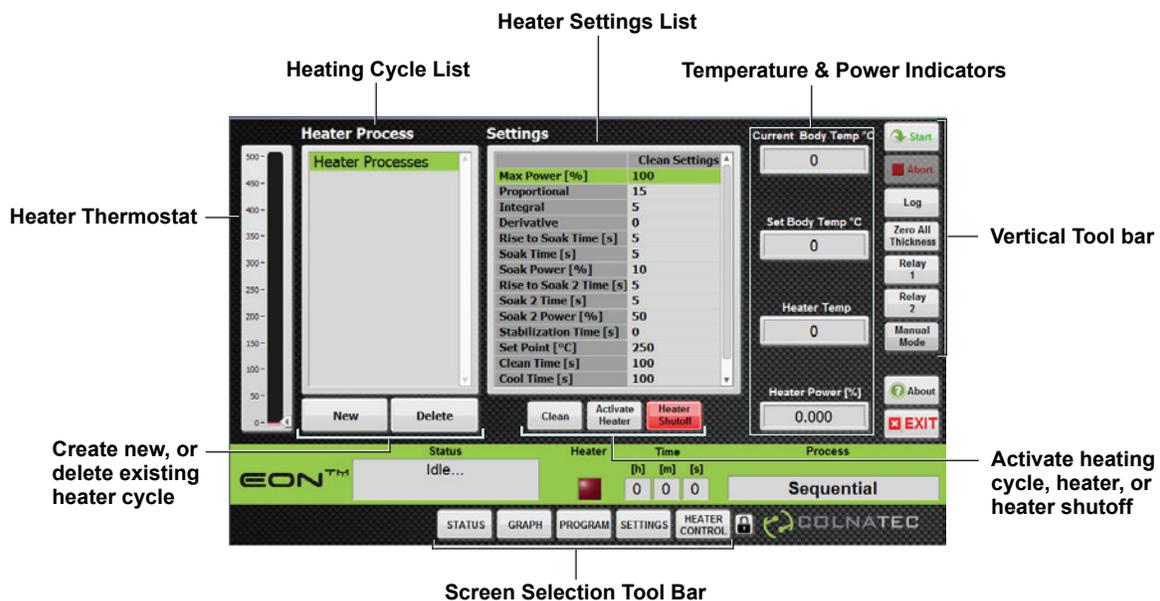
- **Soak Time**
Once the soak power is reached, this is the time specifying how long Eon™ sits at soak power before continuing to “Rise to Predeposit”.
- **Soak Power**
The power percentage that the source will achieve during soak process.
- **Rise to Predeposit**
The time specifying how long it takes Eon to change the current source power to the power percentage set for Predeposit.
- **Predeposit Time**
The time specifying how long Eon™ will maintain the set “Predeposit Power” before moving into dwell.
- **Predeposit Power**
The power percentage that the source will achieve during the Predeposit process.
- **Source**
The source Eon™ uses to control the selected layer/material. The Eon™ has two sources, Source 1 and Source 2.
- **Sensor**
Determines which sensor should be used to control the source selected for the current layer/material.

Heater Control

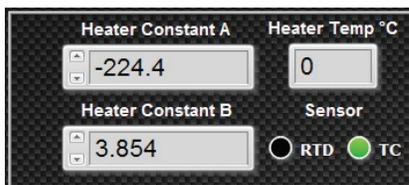
4

Heater Control Screen

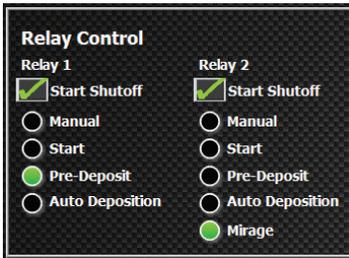
Click the Heater Control button in the Screen Selection tool bar to access the Heater Control screen. With this screen the user will be able to create new heating cycle, edit or delete existing heating cycles, as well as adjust the heater settings.



Adding heater constants. Before the heater can be engaged, the heater constants specific to each sensor must be entered into the heater constant fields on the Settings screen. Click the Settings button in the Screen Selection tool bar. On the Settings screen enter the heater constant data into the Heater Constant A and B fields. The heater constants for the sensor head were included with the paperwork that accompanied your sensor.



Enabling Mirage™. The heater inside the sensor is part of a “temperature compensation” system. Activating the heater requires that each component in this system be made fully operational. In order to activate the heater, the user must first enable the Mirage™. To do so, click Settings in the Screen Selection tool bar and select Mirage™ under Relay 2 in the Relay Control area. The Mirage will now respond to commands issued from the Heater Control screen.



Enable Mirage™



Heating Cycle List

The following section will explain how to create a new heating cycle, and how to edit or remove an existing heating cycle. The list contains all of the available heating cycles.

Create a new heating cycle. Selecting the New button located below the Heating Cycle List will bring up a window that allows the user to create and name a new cycle.

Delete a heating cycle. Selecting Delete will permanently delete the selected heating cycle. Once deleted, a cycle is only recoverable if it was backed up prior.

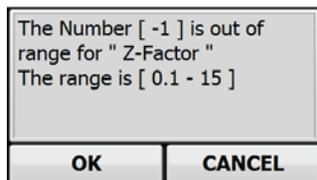
Heater Settings List

With the Heater Settings List, the user will be able to change the operation of the heater, such as sensor body temperature, clean time, and heater initialization.

Change a value on the Heater Settings List. Double-clicking on a selection brings up the Heater Settings Value window, which allows the user to edit the value of the setting.

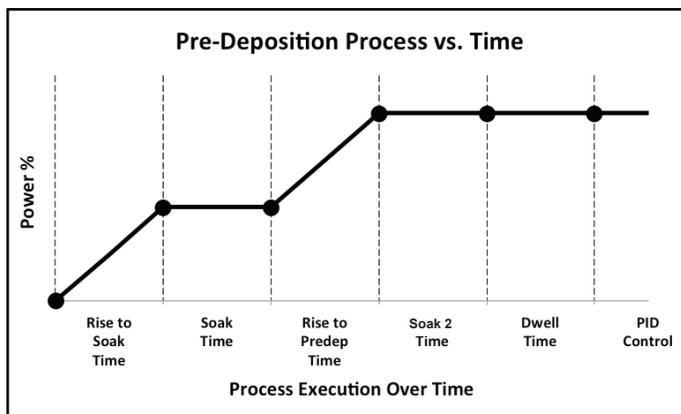


Entering an improper value raises a warning prompt, requiring that the user correct the error or leave the original value in place.



Heater Settings List management. The items below appear on the Heater Settings List. By default the values for these items are set to standard levels. Be sure to go through and adjust each value according to the specific process.

- **Max Power**
Represents the maximum power level Eon™ will deliver to the heater [from 0%-100%], regardless of the power levels being demanded by temperature settings.
- **Proportional**
The proportional coefficient that controls the rate during the PID phase.
- **Integral**
The integral time constant that controls the rate during the PID phase.
- **Derivative**
The derivative time constant that controls the rate during PID phase.

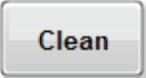


Pre-deposition process vs. time

- **Rise to Soak Time**
The time specifying how long it takes Eon™ to raise heater power from 0% to desired soak power
- **Soak Time**
Once the soak power is reached, this is the time specified that the Eon™ sits at soak power before continuing to Rise to Soak 2.
- **Soak Power**
The power percentage that the source will achieve during soak process.
- **Rise to Soak 2 Time**
The time before Eon™ changes the current source power to the power percentage set for Soak 2.
- **Soak 2 Time**
Time Eon™ will maintain the set Soak 2 power before entering PID mode.

- **Soak 2 Power**
Power percentage that the source will achieve during Soak 2 processes.
- **Stablization Time**
A placeholder for future Eon™ versions that has no effect on heating cycles.
- **Heater Setpoint**
Temperature desired for the heater to reach.
- **Clean Time**
Time the heater will remain at the Heater Setpoint temperature. Once time is complete, heater shuts down and program enters cooling stage.
- **Cool Time**
Time Mirage™ will operate reduce sensor temperature to a desired level.

Heater Control Buttons

The **Clean** button  activates the selected heating cycle, which is used to remove deposited material from the crystal surface.

During a typical Clean procedure, Soak and Soak 2 phases engage. Once soaking is complete, the heater is triggered and guided by the parameters it has been assigned on the Heater Settings List. The program will first raise the sensor body to the **Set Point** temperature, maintain the temperature for the **Clean Time** duration, and then “force-cool” for the time specified by the **Cool Time** entry. Selecting **Heater Shutoff** deactivates a cleaning cycle.

The **Activate Heater** button  manually activates the heater. The program raises the temperature to the **Set Point** and maintains that temperature indefinitely until the heater is manually shutoff. Unlike the Clean button. The Activate Heater button provides no automated control over clean and cool times. Otherwise, just as with the Clean command, the Activate Heater command engages Soak and Soak 2 and triggers the heater. Selecting **Heater Shutoff** deactivates the Activate Heater command.

The **Heater Shutoff** button  instantly deactivates the heater, regardless of current process or cycle status. Note: If selection of Heater Shutoff is not followed by use of a forced-cooling method (e.g., Mirage), the temperature of the sensor head will cool slowly.

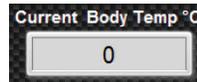
Heater Thermostat

The Heater Thermostat provides real-time display of sensor body temperature.

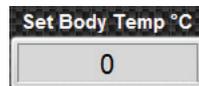
An arrow marker  indicates the current set point for the sensor body temperature.

Temperature & Power Indicators

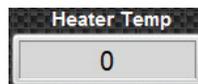
Temperature & Power Indicators provide a live reading of the current temperatures of the sensor body and heater, the preset sensor body temperature, and heater power.



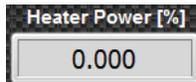
The **Current Body Temperature** indicator displays the current temperature of the sensor head body. If TC is selected in settings then the thermocouple must be connected.



The **Set Body Temperature** indicator displays the target temperature chosen by the user in the Heater Settings list. The heater will engage or disengage as needed to reach this desired temperature.



The **Heater Temperature** indicator displays the temperature of the internal heater engaging or disengaging as needed to reach the desired Set Body Temperature.



The **Heater Power** indicator monitors the power levels the Eon™ is issuing the heater in order to raise or lower heater temperature to achieve the predetermined temperature.



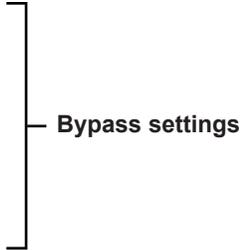
WARNING The Abort button  DOES NOT shut off the heater. The Abort button is used to cancel a process in progress or manual mode only.

Advanced Settings

Skipping soaking steps

When initiating a heat cycle, the user has the option of skipping Soak and Soak 2 and initiating the heating cycle directly. The following settings will allow the heater to enter PID mode to achieve the desired temperature (in this instance a temperature of 125°C):

	Clean Settings
Max Power [%]	100
Proportional	15
Integral	5
Derivative	0
Rise to Soak Time [s]	.1
Soak Time [s]	0
Soak Power [%]	0
Rise to Soak 2 Time [s]	.1
Soak 2 Time [s]	0
Soak 2 Power [%]	0
Stabilization Time [s]	0
Heater Set Point [C]	125
Clean Time [s]	60
Cool Time [s]	30



Bypass settings

Settings

5

Settings Screen

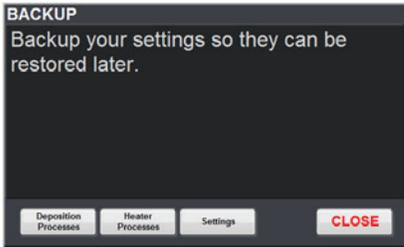
Click the Settings button in the Screen Selection tool bar to access the Settings screen. With this screen the user will be able to perform a variety of tasks, such as backing up and restoring settings, opening the log folder, adjusting period, and managing relays and sensor zeroing settings.



Backup & Restore

The Backup and Restore commands enable the user to save deposition processes, heating cycles, and general settings in Eon™ software.

Selecting Backup  brings up the Backup screen.

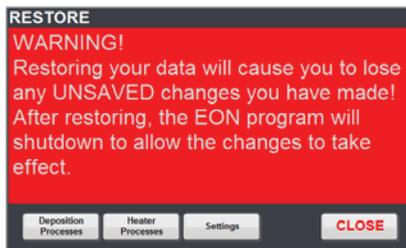


On the Backup screen, click on the item you wish to save.

Restoring backed up settings. Selecting the Restore button

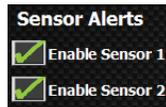


opens the Restore screen.



The user can now restore deposition processes, heating cycles, and general settings by clicking on the appropriate button. Note: The restoration process will overwrite any of the current settings you restore.

Sensor Alerts

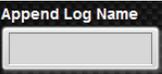


The **Sensor Alerts** setting provides the option of enabling or disabling the crystal failure alerts, which occur when the crystal frequency drifts out of the 5 Mhz - 6 Mhz range.



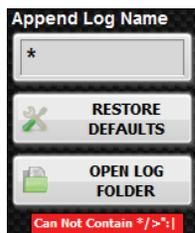
Although it is recommended that the sensor alerts generally remain enabled, the user can disable the notifications in the instance that the crystal is being used in a testing environment.

Log

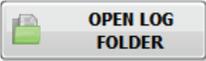
With the **Append Log Name**  feature the user can add a specialized name to the end of the logs recorded by Eon™ software.

Note: If a log recording is already underway, the logging must be restarted for the new name to take effect.

Note: Naming restrictions built into Microsoft Windows will prevent log recording if the following characters are used: [* / > “ : |]. Eon™ software raises a prompt to warn the user that the name is invalid. Log files with incorrect characters in the name will not save.



Removing the invalid character makes the warning disappear.

Opening saved log files. Selecting the **Open Log Folder**  opens the folder to which the logs are currently being saved. By default this location is “Public Documents\EON_LOGS”.

Restore Defaults

The **Restore Defaults** button  reinstates all of the settings to default values. This command is often used if the current settings are producing undesired results.

Period Control

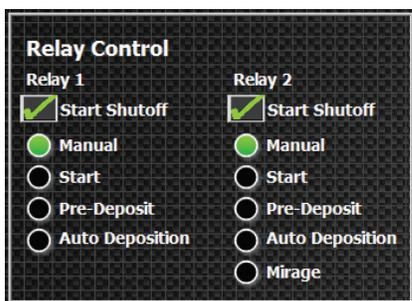
The **Period** control tuner  is used to adjust data collection frequency in increments of 0.1 seconds. The period range is 100 milliseconds to 1 second.

For precision adjustment, moving the slider  produces an indicator showing the current value.

Changing the measurement magnitude  only affects the Status screen. Log files will still be recording in kilo-angstroms.

Relay Control

The **Relay Control** panel features two relays with independent settings.



Applies during deposition only
(automatic control)



Although the two relays are essentially identical, Relay 2 settings contain the additional Mirage™ option, which should be selected when using Mirage™ air-cooling system.

Start Shutoff. When enabled with a checkmark  the Start Shutoff command opens (turns off) the relay each time a process is started. When the relay is used for a shutter, Start Shutoff ensures that the shutter is always shut before the deposition process begins.

If Start Shutoff is disabled  the relay remains in its present state when a deposition process begins.

Manual. When Manual is selected, the relay remains in its present state. The user can close (turn on) or open (turn off) the relay at will.

Start. Relay is closed (turned on) as soon as the process starts.

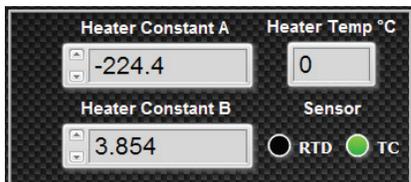
Predeposit. Relay is closed (turned on) at the beginning of the predeposit phase during the predeposition process.

Auto Deposition. Relay is closed (turned on) just before the PID starts, activating as soon as Dwell Time (preset) is initiated. Once Dwell Time concludes, Auto Deposition begins. This process is designed to prevent the Automatic Deposition from engaging prematurely, providing a window of time between the shutter opening and the material reaching the substrate. This selection is specifically designed for shutters.

Mirage™ (Relay 2 Only). When the heater is active, Eon™ uses Relay 2 to control Mirage™. In order to activate the heater, the Relay 2 Mirage option must be selected. While the heater is active, Relay 2 settings cannot be changed (unless the user is in Manual mode [for more about Manual mode, see Chapter 6]).

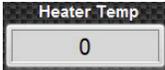
Heater Constant Controls

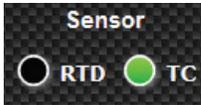
The **Heater Constant controls** are used to calculate heater temperature.



Entering heater constants. The values to be entered are specific to each heater and are usually shipped with the documentation that accompanied your sensor. To enter the values, press the Settings button in the Screen Selection tool bar. Enter the respective values into Heater Constant A and Heater Constant B boxes. Deselect either box or press the Enter key on your keyboard to see values updated.

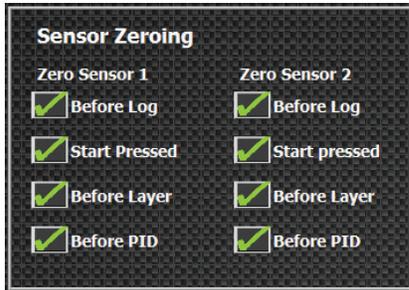
If for some reason the values are unavailable, please contact Colnatec Support at +1 480-634-1449 or support@colnatec.com.

Heater Temp. The Heater Temperature readout  provides current heater readings, which can be useful while setting the heater constants.

Select sensor type. The Sensor Selector option  allows the user to manually select the type of temperature sensor that is used inside the sensor head. Older sensor heads use RTD sensors.

Sensor Zeroing

With the **Sensor Zeroing** panel, the user can select when to zero Sensor 1 or Sensor 2. Settings for each sensor are identical.



Before Log. Pressing Log button  zeros the sensor.

Start Pressed. Pressing Start button  zeros the sensor.

Before Layer. Starting a new layer zeros the sensor.

Before PID. Starting PID zeros the sensor.



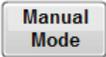
WARNING Failing to zero a sensor before each layer or PID can produce flawed data. Selecting Before Layer or Before PID will ensure timely zeroing.

Manual Mode

6

Manual Control

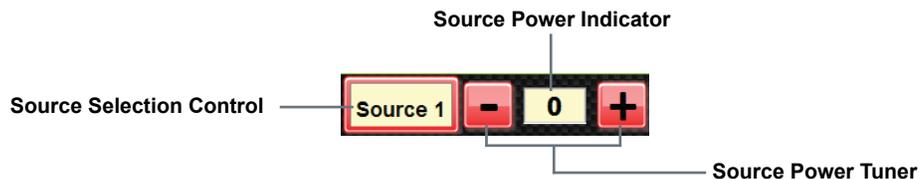
Manual Mode is an alternative operating environment in which the user can exercise manual control over the sources (Source 1, 2, and heater).

To access manual mode, simply click on the Manual Mode button  from any screen.

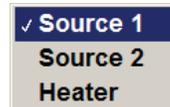
Adjusting Source/Heater Power

Using the following steps, the source and heater power can be manually adjusted by the user through the Manual Mode operating environment:

1. Press Manual Mode from any screen
2. Click on the Source Selection Control to select the source that needs to be manually controlled.



3. Clicking on the Source Selection control produces a dropdown list from which the user can select from available sources.



4. Use the Source Power adjustment buttons to increase or decrease the power of the selected source in increments of 0.1%, OR click directly onto the Source Power indicator and enter a specific power percentage. Then, press Enter.

Note: In order for the program to update the source power, the user must enter a new value and then click in an area other than the Source Power indicator or press enter.

Exiting Manual Mode

Click the Abort button  to exit Manual Mode and return to the standard operating environment.

Note: Pressing the Abort button returns both sources to 0 power.



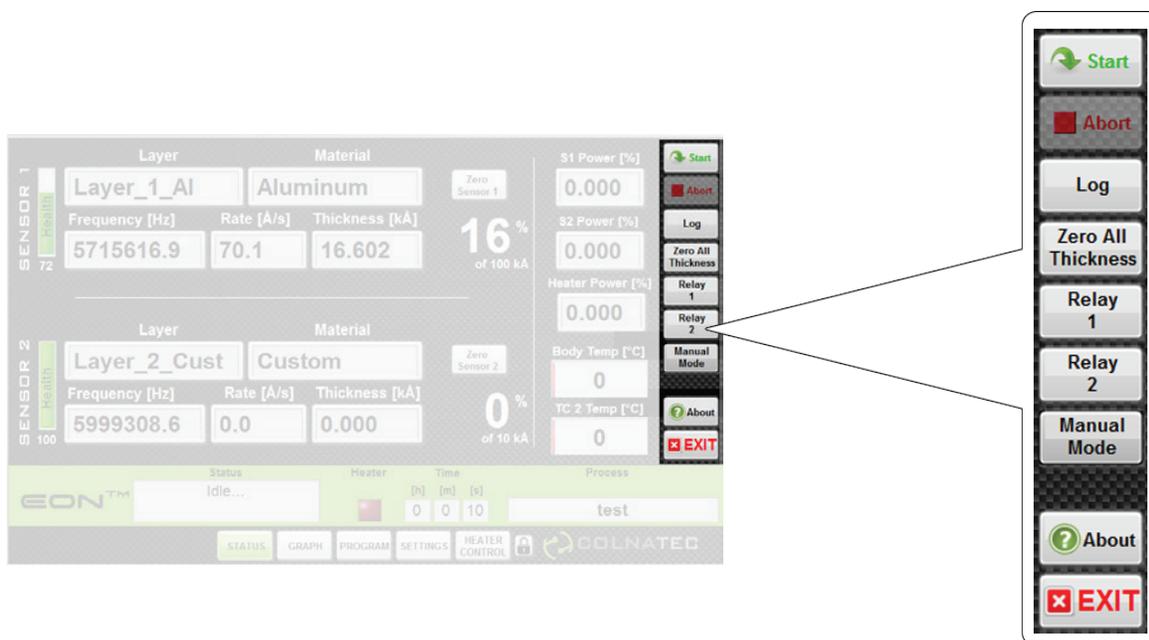
IMPORTANT When the user manually adjusts the value of the source power output, the source will no longer be controlled by the PID, regardless of the current process. If a source is adjusted during a deposition, the Eon™ will no longer control the source controlling the PID or the predeposition processes, as the user has taken full control over the source. This also applies to the heater. Adjusting source power to the heater disables the feature in Eon™ that automatically regulates the temperature of the sensor body, and will also halt the heater from continuing its initialization process if it is currently in one.

Vertical Tool Bar

7

Using the Vertical Tool Bar

Like the Screen Selection tool bar, the vertical tool bar is always available. Use the vertical tool bar to start a deposition, abort a process, record a log, zero the sensors, activate the relays, enter Manual Mode, or exit Eon™ software.



Starting a Deposition

A deposition process can be started from any screen. The process selected in the Process List on the Program Control screen or through the Remote Process Control panel is the process that will run.

Press the Start button  to begin the process. When the process is complete, a Process Complete notification will appear.

Tip: To create a new process, navigate to the Program screen and select New under the Process List.

Aborting a Process

A process can be aborted from any screen. Pressing the Abort button  ends an active process. Abort is also used to exit Manual Mode.

Resume or Restart an Aborted Process

A process can be resumed or restarted from any screen. Press the Start button . A window with the option to Resume or Restart will appear. Make a selection.

Logging Eon™ Status

Eon™ status can be logged to a monitor log from any screen. Pressing the Log button  saves a monitor log to the monitor log save folder (Public/EON_LOGS/MONITORING”).

When a process is initiated, Eon™ software will automatically begin recording the real-time status of the process to the process log folder (Public/EON_LOGS/PROCESSES). If a process is started while an Eon™ monitor log recording is in process, Eon™ will automatically stop recording to the monitor log and begin recording to the process log.

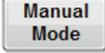
Zeroing the Sensors

The sensors can be zeroed from any screen. Pressing the Zero All Thickness button  zeros Sensor 1 and Sensor 2 at once.

Activating Relay 1 and Relay 2

The Relay 1 and Relay 2 buttons  ,  permit manual control of the relays.

Switching to Manual Mode

The user can switch between the automated software environment and Manual Mode by selecting the Manual Mode button . Manual Mode can be from any screen. As explained in Chapter 6, manual mode makes it possible for the user to take manual control of the sources.

Click the Abort button  to exit Manual Mode and return to the standard operating environment.

Exiting Eon™ Software

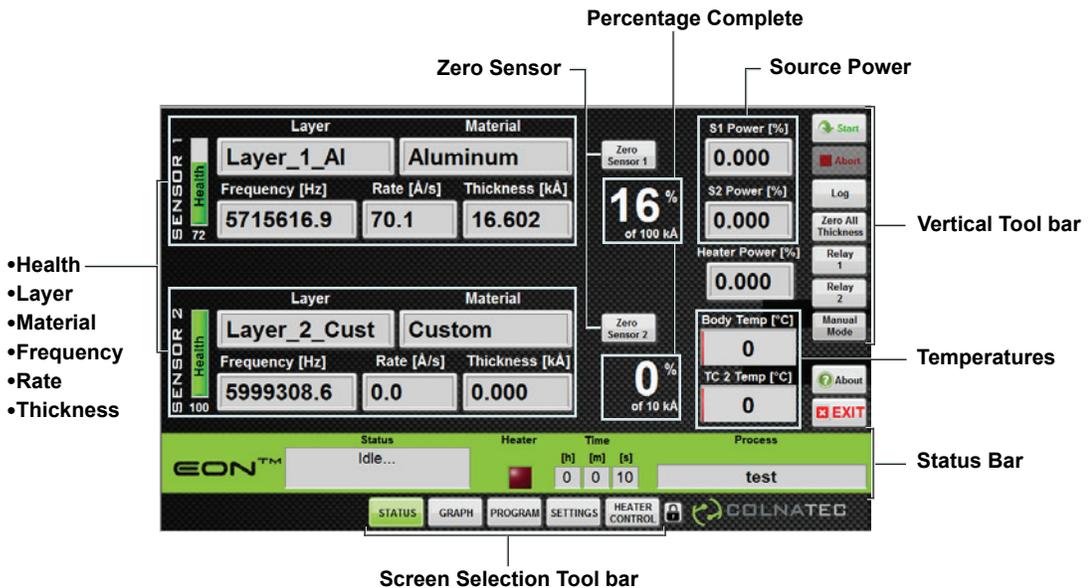
Eon™ software can be exited from any screen. Simply press the Exit button  , and when prompted, press Exit again.



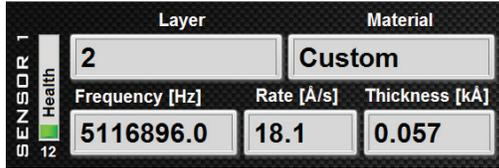
WARNING The Abort button  DOES NOT shut off the heater. The Abort button is used to cancel a process in progress or manual mode only.

Status Screen

Navigate to the Status screen by selecting the Status button in the Screen Selection tool bar. The Status screen displays real-time information on the progress of the process. Data for each sensor is represented - health, layer, frequency, material, rate, thickness, and percentage complete. Important information such as source power and temperature is also displayed.



Health, Layer, Material, Frequency, Rate, and Thickness



Layer. The name of the layer being applied.

Material. When the sensor is being used during a deposition to apply material, the indicator will flash red, informing the user that the sensor is being used to control the selected source for the material being applied. During this process, the material being applied is also displayed.

Frequency. Sensor frequency.

Rate. Rate of deposition.

Thickness. Thickness of deposition applied to sensor.

Zero Sensor

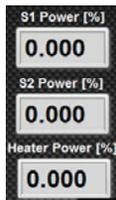
The Zero Sensor buttons   zero corresponding sensor thickness to zero.

Percentage Complete

The Percentage Complete indicators  corresponding sensor thickness to zero.

Source Power

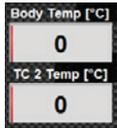
The Source Power indicators display the current power being applied to Source 1 (S1 Power [%]), Source 2 (S2 Power [%]), and heater (Heater Power [%]).



Temperatures

Body Temp. The current temperature of the sensor body, which is connected through TC1.

TC2. Auxillary thermocouple connection.



Manually Zeroing Individual Sensors

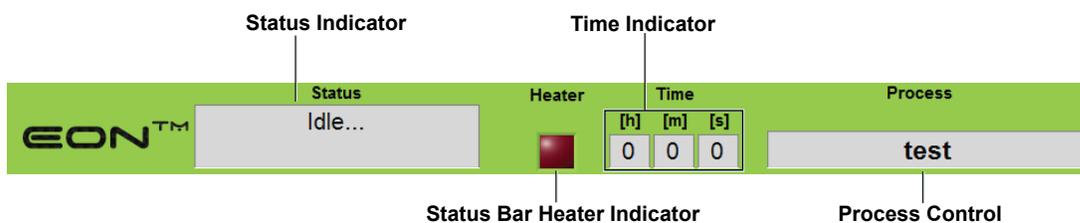
Click the Zero Sensor button that corresponds to the sensor to be zeroed.

Green Status Bar

9

Status Indicators and Remote Process Control

A fixed menu available from any screen, the Green Status bar serves a variety of display and control functions.



Status Indicator. Displays process Eon™ is currently performing. Information updates in real-time as Eon™ performs each task.

Status Bar Heater Indicator. Displays the current status of the heater.



When Eon™ is supplying power to the heater, the indicator turns bright red.

Time Indicator. Displays the run-time of the current active process. The Time Indicator also retains the run-time of the last completed or aborted process.

Remote Process Control. When a process is selected, the Status screen will display the first material to run on each sensor. If no materials are selected to be measured by one of the sensors, the sensor will display **None** in the Layer and Material indicator.

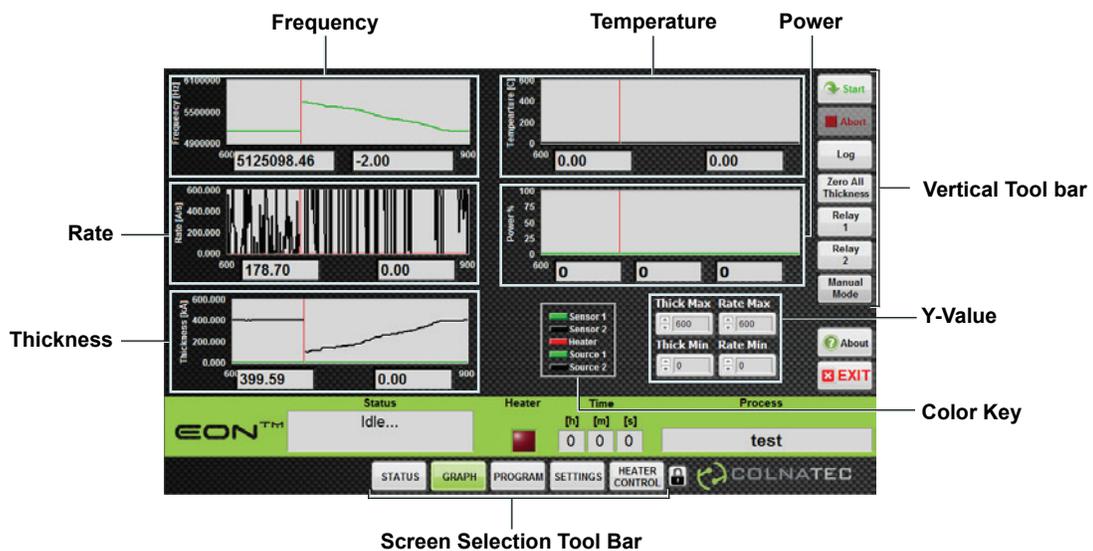
Layer	Material
None	None

Graphs

10

Graph Screen

To view the Graphs screen, click on Graphs in the Screen Selection tool bar. The Graphs screen features line graphs for frequency, temperature, rate, power, and thickness. Unlike real-time data, data in graph-form can provide the user with a comprehensive, historical perspective on a developing deposition process.



Adjusting Y Values

To adjust Y Values, enter the appropriate maximum and minimum for **thickness**  ,

 and for **rate**  ,  .

Graphs

The graphs provide a visual representation of data gathered by Eon™. The following data is presented by the graphs:

- **Frequency**
Displays frequency over time in [Hz]
- **Rate**
Displays the rate of the material application over time in [Å/s].
- **Thickness**
Displays the thickness of material application over time in [kÅ].
- **Temperature**
Displays the temperature over time in [°C].
- **Power**
Displays the power of the sources and heater over time in percentages in [%].

Color Key



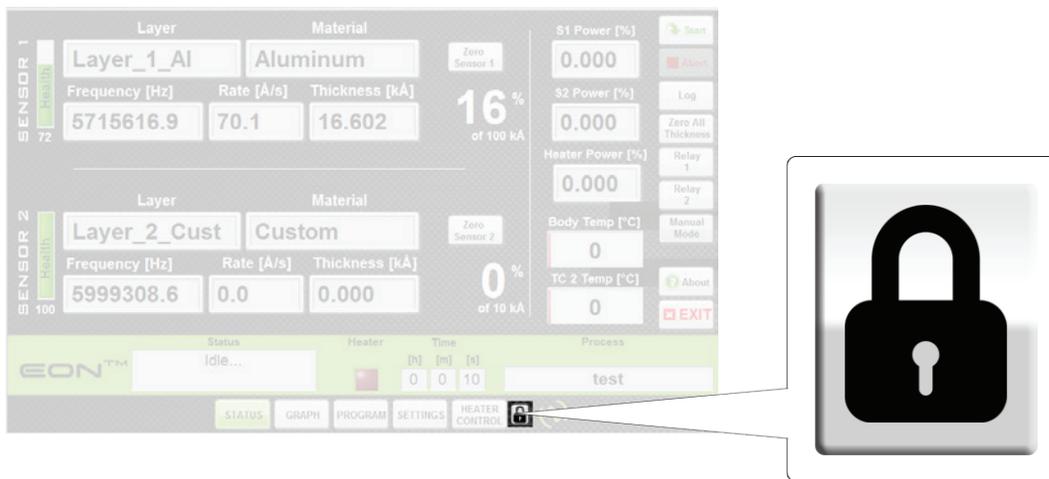
The Color Key displays the color values representing the various devices being depicted on each graph.

Screen Lock

11

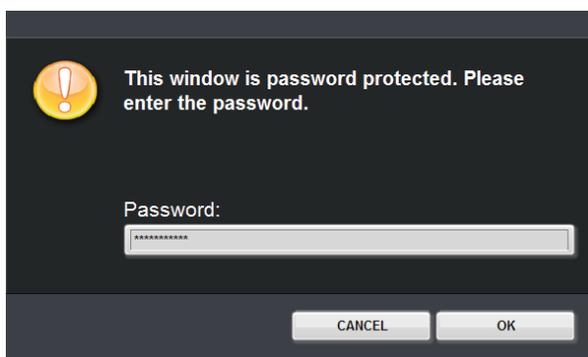
Password-Protect Eon™ Screens

The Eon™ Screen Lock enables the user to lock any screen that appears on the Screen Selection tool bar. Locking a screen helps ensure that the controls and settings on each screen remain secure and under password protection.



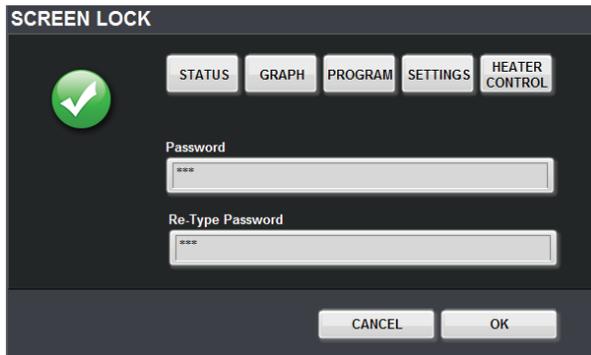
Screen Lock Button

To access the Screen Lock controls, click on the Screen Lock button . If a password is already in place, the password prompt appears.



Entering the correct password will exit to the Screen Lock screen.

If a password is NOT already in place, the Screen Lock screen appears. Use these controls to lock and unlock screens and change the Screen Lock password.



Locking a Screen

On the Screen Lock screen, select the screen(s) to be locked. Selecting a screen highlights it.



Click OK to engage Screen Lock protection. When clicked on, the *protected* screen(s) will now generate a password prompt.

Setting a New Password

The user may keep an existing password or enter a new password using the password controls. In order for a new password to be accepted, the Password and Re-Type Password fields must contain the same password.

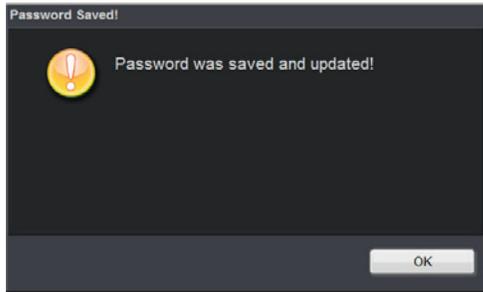


Click OK to save new Screen Lock screen settings or Cancel to return to original settings.



IMPORTANT Leaving password fields empty DOES NOT disable the Screen Lock. Attempting to access a locked screen will continue to produce a password prompt. Leave field blank and click OK to proceed to the Screen Lock menu. To disable the Screen Lock, unclick any locked screens.

Clicking OK saves screen lock and password settings.



Resetting Password

To reset the Screen Lock controls password, click on the Screen Lock button  and enter the following code into password prompt: **45647kyswx94272fyshq**

When the Screen Lock screen appears, enter a new password into the password fields.

Troubleshooting

12

Symptom	Cause	Solution
Frequency reads -2.0 [Hz]	Sensor not detected	Check sensor connection
“Could not connect to Eon Eon™ after 3 seconds” message appears	Wrong COM port selected	Restart and select the correct ComPort
Layer completes immediately	Thickness is set to 0 in the layer	Enter a value other than 0 for the layer
Heater shuts off prematurely	Clean command improperly selected	Use Activate Heater command for your heating cycle
Heater runs without stopping	Acivate Heater improperly selected	Use Clean command for your heating cycle
At program start, a “Wrong Firmware” notification appears, even though the firmware is current	Noise in the RS232 line	Make sure the RS232 line is connected and secure. Separate the RS232 line and any high current power lines.
Crystal warnings fail to appear	Sensor Alerts disabled	Go to Settings screen and enable Sensor Alert for sensor(s) in use

Device Parameters

Density	0.10 to 99.999 [g/cm ³]
Z-Factor	0.10 to 15.00

Coating

Density	0.100 to 99.999 [g/cm ³]
Z-Factor	0.00 to 15.000
Rate Setpoint	0.00 to 9999.99 [Å/s]
Thickness Set Point	0.00 to 9999.99 [KÅ]
Proportional Gain	0.00 to 9999.00 [s]
Integral Time	0.00 to 99.9 [s]
Derivative Time	0.0 to 99.9 [s]
Rise to Soak	0.10 to 9999.9 [s]
Soak Time	0.00 to 9999.99 [s]
Soak Power	0.00 to 100.00 [%]
Rise to Predeposit	0.00 to 999.99 [s]
Predeposit Time	0.00 to 9999.99 [s]
Predeposit Power	0.00 to 100.0 [%]
Dwell Time	0.0 to 9999.9 [s]

Measurement

Frequency Resolution	+/-0.002 [Hz]
Display Rate	10x to 1x per second
Crystal Frequency Range	6 [MHz]
Filter	0-1
Alpha	0-1

Process Display

Film	Selected Material
Layer	Layer Being Deposited
Rate	0.00 to 99.9 [$\text{\AA}/\text{s}$]
Thickness	0.00 to 999.9[K \AA]
Frequency	-3.00 to 6,500,000 [Hz]
Run Time	Hh/mm/ss
Temperature	0 to 999.9 [$^{\circ}\text{C}$]
Health	0.00 to 100 [%]

Communications

Factory Set	RS-232 [PC version]
-------------	---------------------

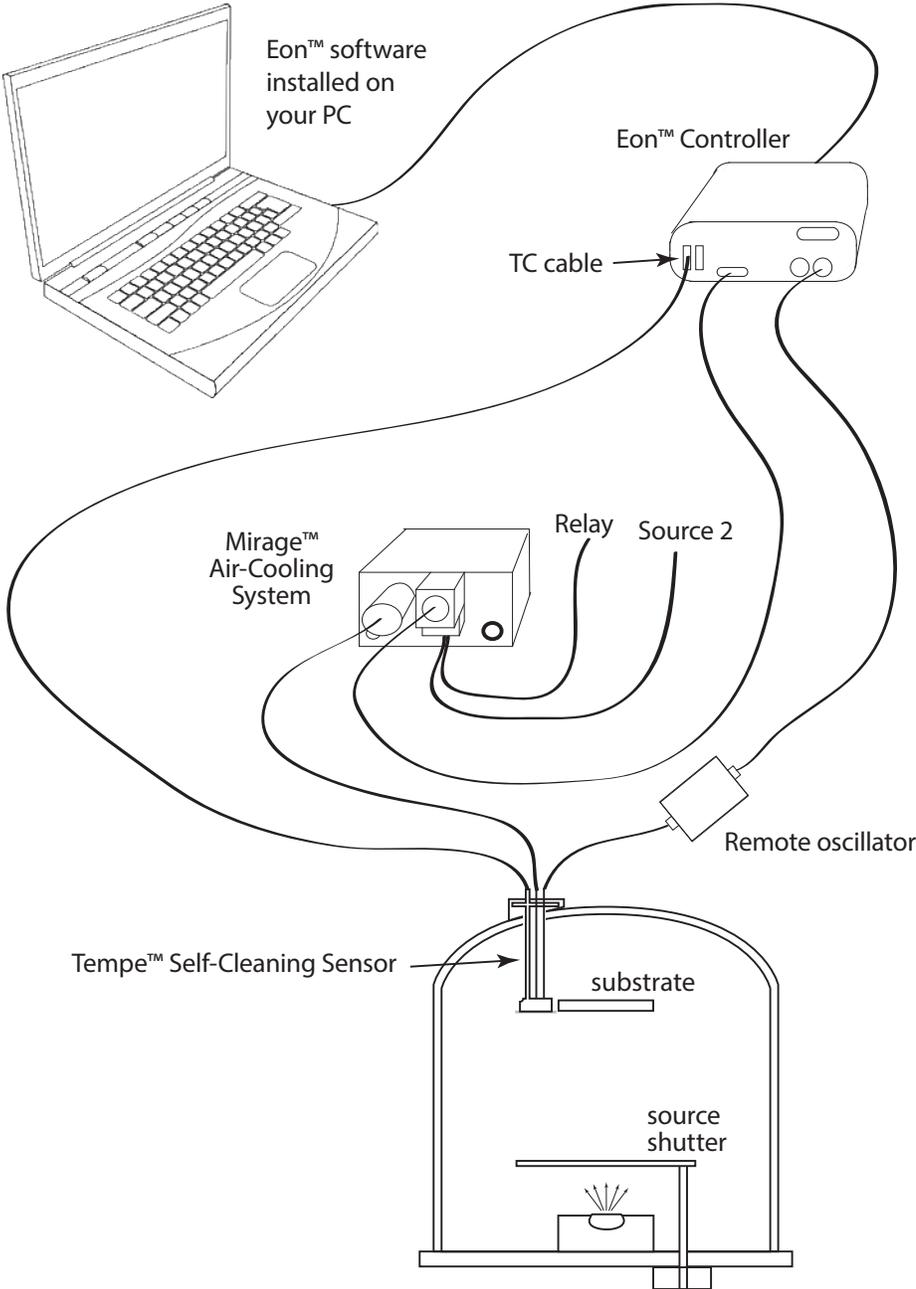
Inputs and Outputs

Voltage input	24 [VDC]
RS232 Input	One Half Duplex
Sensor Input	Two BNC Connector
TC Output	2 Type K Connectors
0-5 [VDC] Control Output	One DB9 Connector
Dual Relay Output	

Tempe-Eon™ System

Tempe-Eon™ System Configuraton

Rendering illustrates basic connections of Tempe-Eon™ system.



Quick Info

B

Appendix

Screen Selection Tool Bar

The Screen Selection Tool Bar is the collection of buttons used to access the various screens in which the user will be working. The buttons consist of Status, Graph, Program, Settings, and Heater Control.



Adding a process

1. Press the Program button to enter the programming screen.
2. Press the New button located beneath the Process List.
3. Enter the desired name for the process.
4. Select the process type - Sequential or Codeposition.
5. Click OK.
6. This process is now selectable through the Process List or the Remote Process Control panel on the Green Status bar.

Note: In order for the program to update the source power, the user must enter a new value and then click away from the Source Power indicator.

Renaming a process

1. Press the Program button on the Screen Selection tool bar.
2. Double click the process you wish to rename.
3. In the new window, enter the new name for the process.
 - Field must not be left blank
 - Name must not already exist
4. Click OK.

Deleting a Process

1. Press the Program button in the horizontal tool bar.
2. On the Process List select the Process to be deleted.
3. Press the delete key directly beneath the Process List.

Edit the name/rate/thickness of a process

1. Click the Program button to enter the Program screen.
2. Click the process that has the layer to edit.
3. Double-click the layer to be edited.
4. Modify the name, rate, and/or thickness.
5. Click OK to save changes.

Adding a layer to a process

1. Press the Program button to access the programming screen.
2. Select the process from the process list. This will open the Process Layers list.
3. Press the New button under the Process Layers list.
4. Enter a new name to create a new layer, or select a layer that has already been created by clicking the arrow on right of the Name and selecting it from the list of layers.
5. Enter the desired Rate in [$\text{\AA}/\text{s}$] and the Thickness in [$\text{k}\text{\AA}$]. Click OK.

Note: The name cannot be left blank. Typing the name of a layer that is already created will use that layer's settings.

Re-Ordering the layers

1. Click and drag the layer to the desired location in the list.
2. Layers are executed in numerical order, from top to bottom.

Changing properties of a layer

1. Press the Program button on the bottom of the screen
2. Select the process in the Process List containing the layer that requires editing.
3. From the Process Layers list select the layer to be edited.
4. Double-click on the Property to be edited.
5. In the new window that opens, enter the new value for the property.
6. Press OK.

Note: If an incorrect value is entered for the property selected, a notification window will appear displaying the acceptable values for that property.

Layer property list

- **Materials:** The material being applied during the deposition process. This entry turns to “Custom” if the Density or Z-Factor is modified by the user.
- **Density [g/cm³]:** The density of the selected material being applied.
- **Z-Factor:** Acoustic impedance factor which is used to compensate for dense materials and is pre-defined based on the selected material.
- **Tooling [%]:** The geometric relationship between the substrate and the positioning of the sensor.
- **Max Power [%]:** Represents the maximum power level Eon™ will deliver to the heater [from 0%-100%], regardless of the power levels being demanded by temperature settings.
- **Proportional:** The Proportional coefficient that controls the material deposition rate during the PID phase.
- **Integral:** The integral time constant that controls the material deposition rate during PID phase.
- **Derivative:** The derivative time constant that controls the material deposition rate during the PID phase.
- **Dwell Time:** The time specified that follows the completion of the pre-deposition process and the activation of the PID. This delay prevents the PID from engaging the source power prematurely, allowing the material to reach the sensor. (No material is applied to the sensor directly after the predisposition process finishes, for the brief time it takes for the material to initially transition from the source to the crystal in the event that a shutter is present).
- **Rise to Soak Time:** The time specifying how long it takes Eon™ to raise source power from 0% to desired soak power
- **Soak Time:** Once the soak power is reached, this is the time specifying how long Eon™ sits at soak power before continuing to “Rise to Predeposit”.
- **Soak Power:** The power percentage that the source will achieve during soak process.
- **Rise to Predeposit:** The time specifying how long it takes Eon to change the current source power to the power percentage set for Predeposit.
- **Predeposit Time:** The time specifying how long Eon™ will maintain the set “Predeposit Power” before moving into dwell.
- **Predeposit Power:** The power percentage that the source will achieve during the Predeposit process.
- **Source:** The source Eon™ uses to control the selected layer/material. The Eon™ has two sources, Source 1 and Source 2.
- **Sensor:** Determines which sensor should be used to control the source selected for the current layer/material.

Removing a Layer

1. Press the Program button in the Screen Selection tool bar.
2. From the process list, select the Process with the layer that needs to be removed.
3. In the Process Layers, list select the layer that needs to be removed.
4. Press Remove directly beneath the Process Layers list.

Note: Removing the layer only removes the layer from the Process Layers list. The layer can be re-added to the list by pressing “New” and selecting the layer from the dropdown menu. See “Adding a process” on the first page of this appendix.

Deleting a Layer

1. Press the Program button on Screen Selection tool bar to enter the Program screen.
2. Select a process that contains the layer to be deleted.
3. After selecting the Layer from the Process Layers list, press Permanently Delete Layer to delete the layer.

Warning: This action will permanently delete the layer from ALL processes. The layer will also be deleted from the list of layers. There is no way to recover a layer once it is deleted.

Changing the material for a layer

1. In the Program screen, select the layer with the material to be changed.
2. Double-click on the Material row.
3. In the new window select a new material.
4. Click OK.

Note: When editing Density or Z-Factor, the material value defaults to Custom to prevent contradictions from occurring between the material and the material values.

Selecting sensor and source of layer

Co-Deposition

1. In the Program screen, select the layer to which a sensor/source will be added.
2. Click on the Sensor/Source selection animation to change the sensor/source combination.

Sequential Deposition

3. In the Program screen, select the layer to which a sensor/source will be added.
4. In the Layer Properties list, scroll down to the Sensor or Source row and double-click.
5. In the new window, click the animation until the desired sensor/source setup is displayed
6. Click OK.

Heater control

Activating the heater

1. Press the Heater Control button to enter the Heater Control screen.
2. Select the Process list and, then, the heater process to be run.
3. Press the Activate Heater button under the Settings list.

Shutting off the heater

1. Press the Heater Control button to enter the Heater Control screen.
2. Press the Heater Shutoff button under the Settings list.

Note: Abort does NOT shut off the heater!

Creating a heater process

1. Press the Heater Control button to enter the Heater Control screen.
2. Press the New button located under the Heater Process list.
3. In the new window that appears, enter the desired name for the new heater processes.
4. Click OK.

Cleaning the Sensor with the heater

1. Press the Heater Control button to enter the Heater Control screen.
2. Select the Process list and, then, the heater process to be run.
3. Press the Clean button under the settings list.

Clean Settings

- **Max Power:** This is the maximum power that the Eon™ will send to the heater, regardless of the temperature. This means if the temperature set requires the heater power to go above the maximum, the Eon™ will prevent the heater from going any farther and will stay at the maximum power limit.
- **Proportional:** This is the proportional coefficient to control the material deposition rate during the PID phase.
- **Integral:** The integral time constant to control the material deposition rate during the PID phase.
- **Derivative:** Derivative time constant to control the material deposition rate during the PID phase.
- **Rise to Soak Time:** This is the time span that the Eon™ will raise the source power from 0% to the desired soak power.
- **Soak Time:** Once the soak power is reached, this is the time the Eon™ will sit at soak power before continuing to Rise to Predeposit.
- **Soak Power:** This is power percentage that the source will achieve during the soak process.
- **Rise to Soak 2 Time:** This is the amount of time that the Eon™ will take to change the current source power to the power percentage set for Predeposit.
- **Soak 2 Time:** This is the time that the Eon™ will maintain the set Predeposit Power before entering PID mode.
- **Soak 2 Power:** This is the power percentage that the source will achieve during the Soak 2 Processes.
- **Stabilization Time:** This is not implemented and is a place holder for future versions. Values here will not affect the heating process.
- **Heater Setpoint:** This is the desired temperature for the heater to reach
- **Clean Time [Clean Only]:** This is the time that the heater will remain at the Heater Setpoint temperature before cooling off.
- **Cool Time [Clean Only]:** This is the amount of time the mirage will cool the heater off after the Clean Time has passed.

Vertical toolbar

Starting a deposition

1. A deposition can be started from any screen.
2. Ensure that the desired process to run is selected in the Remote Process Control panel on the Green Status bar.
3. To start the process, press the Start button on the vertical tool bar.
4. Wait for the Process Complete notification to appear.

Abort button to end a process or exit Manual Mode

1. From any screen, press the Abort button to end a process or exit Manual Mode.

Note: Abort does NOT shut off the heater!

Resuming an Aborted Process

If a process has been aborted before it has been completed, and a new process has not been selected, the original process can be resumed.

1. To resume a process, press the Start button from any screen.
2. When prompted to Resume or Restart, press Resume.

Logging the status of the Eon™

1. Press the Log button on the vertical tool bar.

Note: Eon™ status can be logged to a monitor log from any screen. Pressing the Log button saves a monitor log to the monitor log save folder (MyDocuments/eon_logs/monitoring”).

When a process is initiated, Eon software will automatically begin recording the real-time status of the process to the process log folder (MyDocuments/eon_logs/processes). If a process is started while an Eon™ monitor log recording is in process, Eon™ will automatically stop recording to the monitor log and begin recording to the process log.

Zeroing Both Sensors Manually

1. Press the Zero All Thickness button on the Screen Selection tool bar.

Activating Relays Manually

1. The relays can be activated from any screen.
2. On the Screen Selection tool bar, toggle the Relay # button to activate the relays.

Activating Manual Mode

1. The user can switch between the automated software environment and manual environment.
2. From any screen select the Manual Mode button.

Note: During manual mode, the Manual Mode button blinks red.

Exiting Eon™ Software

1. Eon™ software can be exited from any screen.
2. Press the Exit Button
3. When prompted, press Exit again.

Adjusting the Source/Heater Power

1. On the vertical tool bar, press Manual Mode from any screen.
2. Click on the manual mode selector and select the source/heater to be manually controlled.
3. Use the “+” and “-” buttons to increase and decrease power of the selected source. OR click on the power percentage control and type the desired power percentage.

Note: Adjusting a source or the heater in manual mode will cause the source/heater to relinquish automatic control by the Eon™. The Manual Mode environment will be in full control of that source or heater.

Exiting Manual mode

1. Press the Abort button to exit Manual Mode from any screen.

Settings

Note: All settings are automatically updated and saved as soon as they are changed.

Adjusting Eon™ period readings

1. Press the Settings button on the Screen Selection tool bar.
2. Click and drag the marker on the Period control to adjust the period time in increments of 100ms.

Changing Thickness Units [KA, A]

1. Press the Settings button on Screen Selection tool bar.
2. Select the desired thickness measurement units.

Entering the Heater Constants

1. Press the Settings button on the Screen Selection tool bar.
2. Enter the value of Heater Constant A and Heater Constant B.
3. Update the values by unselecting the box or pressing enter.

Note: The heater constants ensure that the heater functions correctly. Each heater has its own unique values. These values can be found in the documentation that ships with the product. If these values are unavailable, please contact Colnatec Support at support@colnatec.com or call 480-634-1449.

Disable/Enable Sensor Failure Alerts

1. Press the Settings button on the Screen Selection tool bar.
2. Under the Sensor Alerts section, check or uncheck the checkmark box of the corresponding sensor to enable or disable failure alerts.
 - Checked: Shows sensor failure alerts
 - Unchecked: Hides sensor failure alerts

Note: Sensor failure alerts can be toggled on or off to prevent these notifications from being displayed.

Append a Log Name to Log files

1. Press the Settings button on the Screen Selection tool bar.
2. Enter text to append a log filename
 - Leave blank if you do not wish to append a filename

Note: Using the characters */>":| will cause the filename to be invalid and can prevent logs from being recorded.

Restore Default Settings

1. Press the Settings button on the Screen Selection tool bar.
2. Press the Restore Defaults button on the settings screen.

Force Relays to shutoff when a process is started

1. Press the Settings button on the Screen Selection tool bar.
2. In the Relay Control section, check Start Shutoff for the desired relay you wish to shutoff on process start.

Set when relays activate during deposition process

1. Press the Settings button on the Screen Selection tool bar.
2. In the Relay Control section, select the round radio button associated with the step during the deposition process when the relay should activate.
 - Manual: The relays will not activate during the deposition process automatically, but can still be controlled by the Relay # button.
 - Start: At the start of each layer/material in the process the relay will activate and will de-activate at the end of each material.
 - Pre-Deposit: The relay will activate during the pre-deposit phase of the deposition process for each layer/material. The relay will then shutoff at the end of the deposition process.
 - Auto Deposition: The relay will activate during the dwell phase, just before the PID activation. This allows the dwell time to occur between shutters release and PID activation.
 - Mirage: Eon™ uses Relay 2 to activate Mirage™ when the Tempe™ heater is engaged. Mirage™ MUST be selected before the heater can be used, allowing Eon™ to control Relay 2 automatically during the deposition process.

Setting when Eon™ automatically zeros sensor thickness

1. Press the Settings button on the Screen Selection tool bar.
2. In the Sensor Zeroing menu, checkmark each setting associated with the sensor that is to have its thickness automatically zeroed.
 - Before Log: Eon™ zeros thickness when Log button is pressed.
 - Start Pressed: Eon™ zeros thickness when Start” button is pressed to start a new deposition.
 - Before Layer: Eon™ zeros thickness each time a new layer/material engages during the process.
 - Before PID: Eon™ zeros thickness each time a new layer/material activates the PID.

Safety, Handling, & Support



WARNING All electrical components are to be considered extremely dangerous if tampered with in any way. Colnatec is not liable for any injury resulting from product misuse, modification, or disassembly.



WARRANTY LABEL If the warranty label has been tampered with, “VOID” will appear where the warranty label was originally placed. If this is visible at the time of arrival, it is important that you contact Colnatec immediately after receiving the product.



EXAMINE YOUR NEW EON™ FOR ANY SIGNS OF PHYSICAL DAMAGE. ALSO, ENSURE THAT THE TAMPER-EVIDENT LABELS ARE INTACT Before shipping, your Eon™ was calibrated and tested by Colnatec to meet the highest quality standards. It is important that you take a few minutes to inspect the product to ensure that your equipment was not damaged or otherwise tampered with during transit.

About Eon™

With the ability to sense deposition and temperature with high precision, the Eon™ thin film controller is one of the newest advancements in Thin Film deposition controllers. The Eon™ provides features that help improve measurement accuracy for better process control.

LabVIEW® Interface

The Eon™ offers a simple LabVIEW® interface that provides an operating environment that is intuitive, efficient, and impressive. The Eon™ is easy to set up right out of the box.

Software Updates

The Eon™ interface software can be upgraded on site to provide software improvements. There will be notifications when these updates become available.

Inspection & Initial Setup

Examine Eon™ for any signs of physical damage. Also, make sure that the tamper-evident labels are intact. In order to ensure safe, correct operation of your Eon™, please follow the step-by-step instructions presented in the Eon™ Quick Start guide included with your product.

Warranty

Eon™ is warranted to the original purchaser to be free of any manufacturing-related defects for one year from the date of purchase. Colnatec reserves the right to repair or replace the unit after inspection.

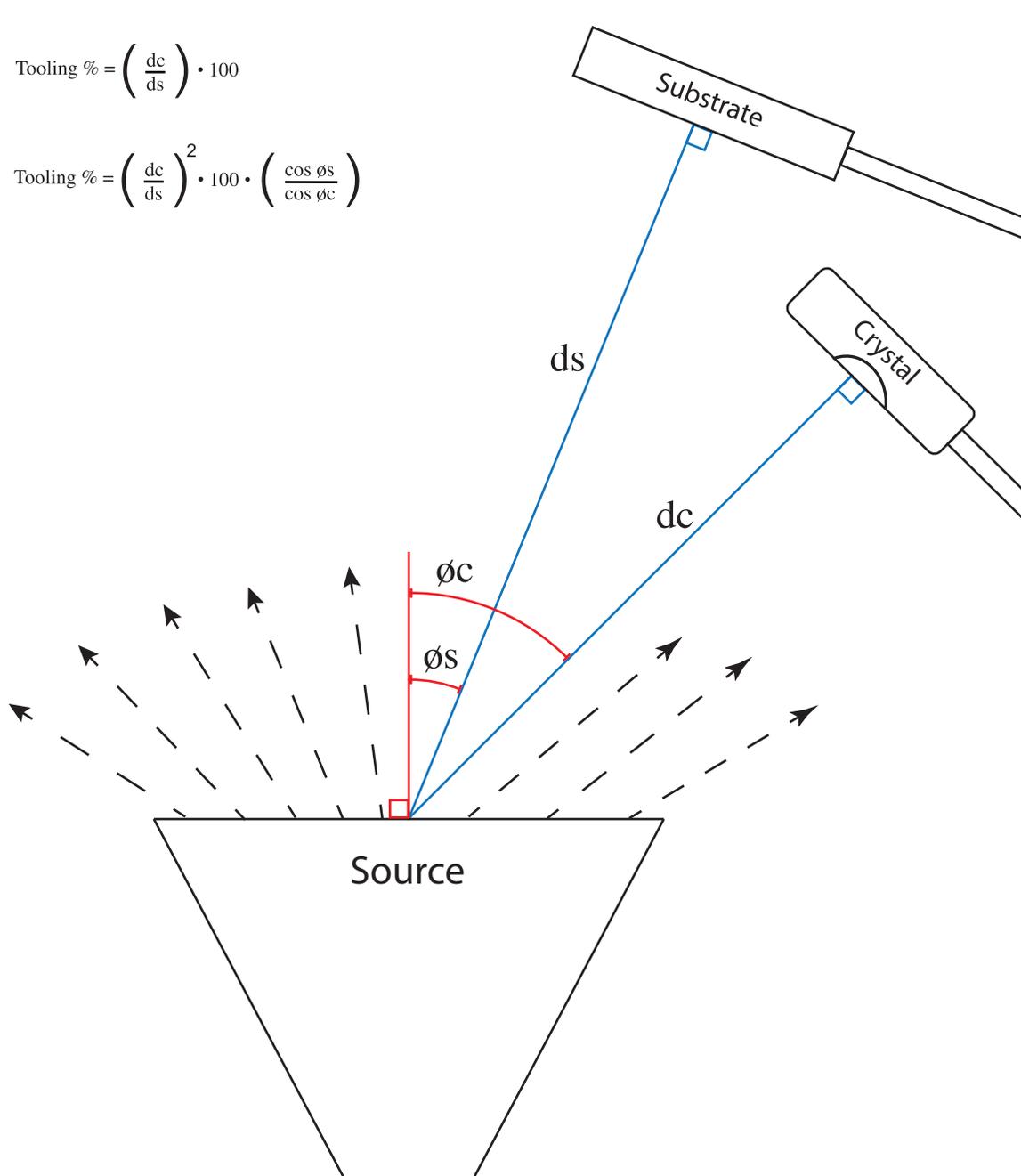
Contact Colnatec Support

511 W. Guadalupe Road, Suite 23
Gilbert, AZ 85233
(480) 634-1449
support@colnatec.com
www.colnatec.com

Tooling Factor

$$\text{Tooling \%} = \left(\frac{dc}{ds} \right) \cdot 100$$

$$\text{Tooling \%} = \left(\frac{dc}{ds} \right)^2 \cdot 100 \cdot \left(\frac{\cos \phi_s}{\cos \phi_c} \right)$$



Index

A

Abort 30, 39, 41, 42, 61, 63, 64
Aborting a Process 41
About Eon™ 68
Accessories 9
Activate Heater 29, 52, 61
Activating Relay 1 and Relay 2 41
Adjusting Y Values 47
Advanced Settings 31

B

Backup 32, 33
Backup & Restore 32
Body temperature 27, 30

C

Clean 28, 29, 31, 52, 62, 71
Clean Settings 31, 62
Coating 53
Color Key 47, 48
Communications 54
Copyright 73

D

Deleting a Process 57
Drivers 19

E

Eon™ at a Glance 7, 8, 9, 10, 11, 12, 13
Eon™ Connectors 7
Eon™ System Assembly 14
Exiting 39, 42, 64
Exiting Eon™ Software 42, 64
Exiting Manual Mode 39

F

Frequency 33, 34, 43, 44, 47, 48

Index

G

Getting Started 14, 15, 16, 17, 18, 19
Graph 47, 57
Graphs 47, 48
Graph Screen 47
Green Status Bar 46

H

Health 44, 54
Health, Layer, Material, Frequency, Rate, and Thickness 44
Heater 14, 15, 24, 26, 27, 28, 29, 30, 31, 35, 36, 38, 39, 42, 44, 46, 48, 59, 61, 62, 63, 64, 65, 66
 Constant 26, 36
 Control 14, 15, 26, 27, 28, 29, 30, 31, 57, 61, 62
 Control Buttons 29
 Control Screen 26
 Power 30, 38, 44, 64
 Settings 26, 27, 28, 29, 30
 Settings List 26, 27, 28, 29
 Shutoff 26
 Thermostat 26, 30
Heating Cycle 26, 27, 29, 31, 52
Heating Cycle List 26, 27

I

Inputs and Outputs 55, 71
Inspection & Initial Setup 68

L

Layer 20, 21, 22, 25, 37, 43, 44, 52, 58, 59, 60, 61, 66
 New 21, 37, 58, 66
 Deleting 60
 Moving (change order) 21
Layer Properties Defined 24
Layer Properties list 61
Layer Properties List 20, 21, 22, 23
Layers list 58, 60
Locking a Screen 50
Log 32, 34, 37, 41, 63, 65, 66
Log files 34, 65
Logging Eon™ Status 41

Index

M

Manual Control 38
Manually Zeroing Individual Sensors 45
Manual Mode 38, 39, 40, 41, 63, 64
Material 22, 24, 25, 28, 29, 35, 43, 44, 46, 48, 59, 60, 62, 66
Measurement 54
Mirage™ Air-Cooling System 12

P

Password 49, 50, 51
Password-Protect Eon™ Screens 49
Percentage Complete 43, 44
Period Control 32, 34
Predeposition 35, 39
Process Display 54
Process List 20, 40, 57, 58
Program 20, 21, 22, 23, 24, 40, 46, 57, 58, 60, 61
Program Control 20, 21, 22, 23, 24, 40
Program Control Screen 20

Q

Quick Info 57

R

Rate 21, 24, 28, 29, 43, 47, 48, 58, 59, 62
Relay Control 27, 32, 35, 66
Removing a Layer 60
Restore 32, 33, 34, 66
Restore Defaults 32, 34, 66
Resume or Restart an Aborted Process 41
RS232 52
RTD 7, 14, 36

Index

S

Safety 67, 68, 69
Screen Lock 49, 50, 51
Screen Lock Button 49
Screen Selection Tool Bar 20, 26, 32, 57
Sensor Alerts 32, 33, 65
Sensor zeroing 32
Sensor Zeroing 32, 37, 66
Setting a New Password 50
Settings 26, 27, 28, 29, 30, 31, 32, 33, 34, 35, 36, 37, 57, 61, 62, 65, 66
Settings Screen 32
Shutter 24, 35, 59
Software Updates 68
Source 7, 16, 24, 25, 28, 38, 39, 43, 44, 57, 59, 61, 62, 64
Source Power 38, 43, 44, 57
Starting a Deposition 40
Status 29, 41, 46, 63
Status 34, 41, 43, 44, 45, 46, 57, 63
Status Indicators and Remote Process Control 46
Status Screen 43
Support 36, 65, 67, 68, 69
Switching to Manual Mode 41

T

TC (Thermocouple) 30, 45, 55
Tempe-Eon™ System 56
Tempe-Eon™ System Configuraton 56
Temperature & Power Indicators 26, 30
Temperatures 43, 45
Tooling Factor 70

Thickness 21, 43, 44, 47, 48, 58, 65, 66
Time 23, 24, 25, 27, 28, 29, 35, 41, 43, 46, 47, 48, 59, 62, 63, 65, 66, 67

U

Units 65
Update 65
Updates 68
USB 7, 10, 18, 19
Using the Vertical Tool Bar 40

Index

V

Vertical Tool Bar 40, 41, 42, 47

W

Warranty 67, 68

Z

Zeroing the Sensors 41

Zero Sensor 43, 44, 45

© Copyright 2014 Colnatec

All information contained within this technical manual and accompanying pages are copyright of Colnatec. All rights reserved. It is a breach of copyright if this technical manual is copied, distributed, or reproduced, in whole or part, using any means whatsoever, without the prior written approval of Colnatec.

Colnatec gives no condition or warranty, expressed or implied, about the fitness of this technical manual or accompanying hardware product. Colnatec reserves the right to make changes to this technical manual or accompanying hardware or design without notice to any person or company.

Colnatec shall not be liable for any indirect, special, consequential or incidental damages resulting from the use of this technical manual or the accompanying hardware or design whether caused through Colnatec's negligence or otherwise.

August 2014
Ver. 3.0.8